imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



PD - 95461

I_D

15A

International

IRF7455PbF

SMPS MOSFET

VDSS

30V

HEXFET[®] Power MOSFET

R_{DS(on)} max

0.0075Ω

Appl	ications
------	----------

High Frequency DC-DC Converters
with Synchronous Rectification

• Lead-Free

Benefits

- Ultra-Low R_{DS(on)} at 4.5V V_{GS}
- Low Charge and Low Gate Impedance to Reduce Switching Losses
- Fully Characterized Avalanche Voltage and Current

	50550
Top View	SO-8

Absolute Maximum Ratings

Symbol Parameter		Max.	Units	
V _{DS}	Drain-Source Voltage	30	V	
V _{GS}	Gate-to-Source Voltage	± 12	V	
$I_D @ T_A = 25^{\circ}C$ Continuous Drain Current, $V_{GS} @ 10V$		15		
$I_D @ T_A = 70^{\circ}C$ Continuous Drain Current, V _{GS} @ 10V		12	A	
IDM Pulsed Drain Current①		120		
P _D @T _A = 25°C Maximum Power Dissipation3		2.5	W	
$P_D @T_A = 70^{\circ}C$	Maximum Power Dissipation3	1.6	W	
	Linear Derating Factor	0.02	W/°C	
T _J , T _{STG}	Junction and Storage Temperature Range	-55 to + 150	°C	

Thermal Resistance

	Parameter	Max.	Units
R _{0JA}	Maximum Junction-to-Ambient	50	°C/W

Typical SMPS Topologies

• Telecom 48V Input Converters with Logic-Level Driven Synchronous Rectifiers

Notes ① through ④ are on page 8

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	30		-	V	$V_{GS} = 0V, I_D = 250 \mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.029		V/°C	Reference to 25°C, I _D = 1mA
	Static Drain-to-Source On-Resistance		0.0060	0.0075	Ω	$V_{GS} = 10V, I_D = 15A$ ④
R _{DS(on)}			0.0069	0.009	1 12	V _{GS} = 4.5V, I _D = 12A ④
			0.010	0.020		$V_{GS} = 2.8V, I_D = 3.5A$ ④
V _{GS(th)}	Gate Threshold Voltage	0.6		2.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
lass	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 24V, V_{GS} = 0V$
IDSS				100	PA	$V_{DS} = 24V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			200	nA	$V_{GS} = 12V$
	Gate-to-Source Reverse Leakage			-200	nA	V _{GS} = -12V

Static @ T_J = 25°C (unless otherwise specified)

Dynamic @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
g _{fs}	Forward Transconductance	44			S	$V_{DS} = 10V, I_{D} = 15A$
Qg	Total Gate Charge		37	56		I _D = 15A
Qgs	Gate-to-Source Charge		8.9	13	nC	$V_{DS} = 24V$
Qgd	Gate-to-Drain ("Miller") Charge		13	20	t	V _{GS} = 5.0V, ③
t _{d(on)}	Turn-On Delay Time		17			$V_{DD} = 15V$
tr	Rise Time		18		ns	$I_{D} = 1.0A$
t _{d(off)}	Turn-Off Delay Time		51	-	115	$R_G = 6.0\Omega$
tf	Fall Time		44		1	V _{GS} = 4.5V ③
Ciss	Input Capacitance		3480			$V_{GS} = 0V$
Coss	Output Capacitance		870			$V_{DS} = 25V$
Crss	Reverse Transfer Capacitance		100		pF	f = 1.0MHz

Avalanche Characteristics

	Parameter	Тур.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy@		200	mJ
I _{AR}	Avalanche Current®		15	A
E _{AR}	Repetitive Avalanche Energy®		0.25	mJ

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
Is	Continuous Source Current (Body Diode)	_		2.5		MOSFET symbol showing the integral reverse p-n junction diode.	
I _{SM}	Pulsed Source Current (Body Diode) ①	_		120	A		
V _{SD}	Diode Forward Voltage			1.2	V	$T_J = 25^{\circ}C, I_S = 2.5A, V_{GS} = 0V$ 3	
trr	Reverse Recovery Time		64	96	ns	$T_J = 25^{\circ}C, I_F = 2.5A$	
Qrr	Reverse RecoveryCharge		99	150	nC	di/dt = 100A/µs ③	

International **tor** Rectifier

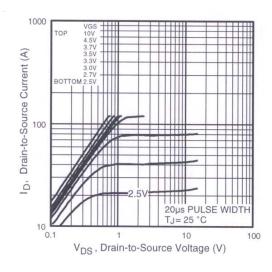


Fig 1. Typical Output Characteristics

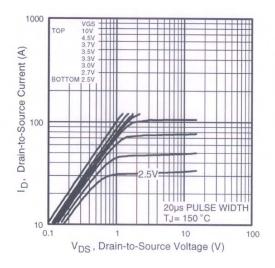


Fig 2. Typical Output Characteristics

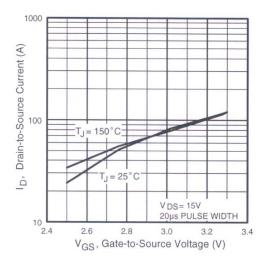


Fig 3. Typical Transfer Characteristics

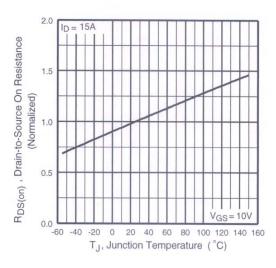
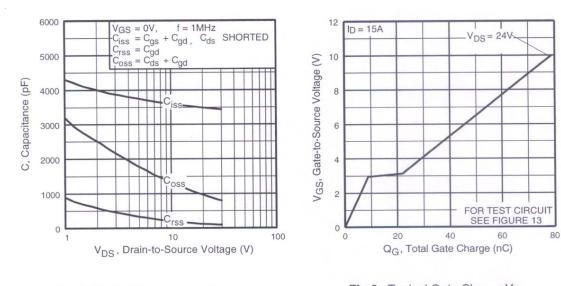


Fig 4. Normalized On-Resistance Vs. Temperature

International





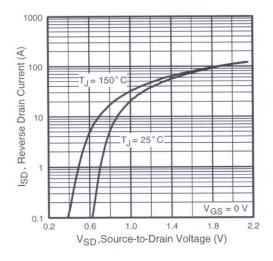




Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

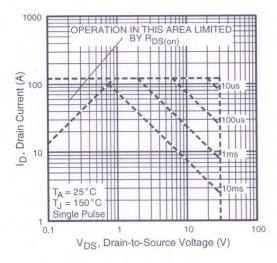
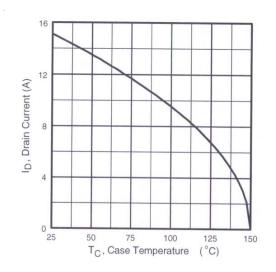


Fig 8. Maximum Safe Operating Area

International **IGR** Rectifier





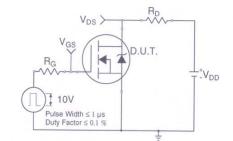


Fig 10a. Switching Time Test Circuit

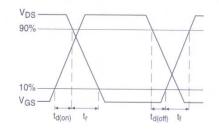


Fig 10b. Switching Time Waveforms

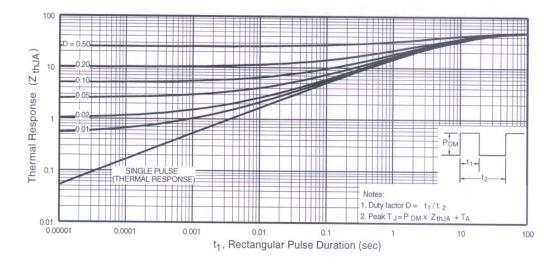


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

International **IOR** Rectifier

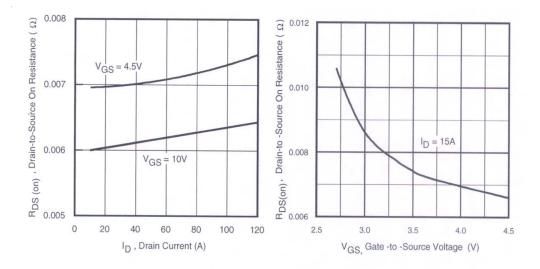


Fig 12. On-Resistance Vs. Drain Current

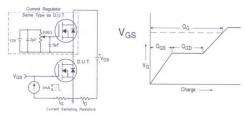


Fig 13a&b. Basic Gate Charge Test Circuit and Waveform

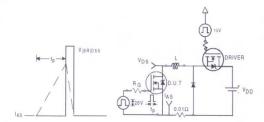


Fig 14a&b. Unclamped Inductive Test circuit and Waveforms

Fig 13. On-Resistance Vs. Gate Voltage

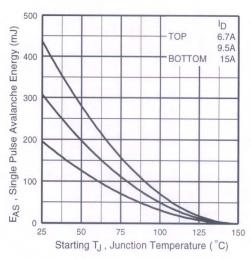
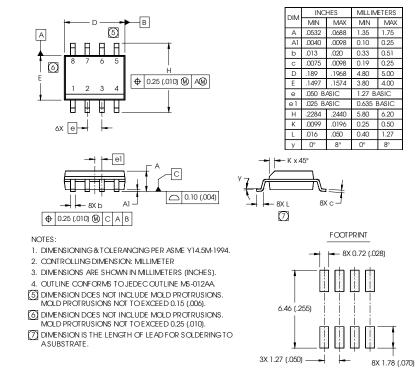


Fig 14c. Maximum Avalanche Energy Vs. Drain Current

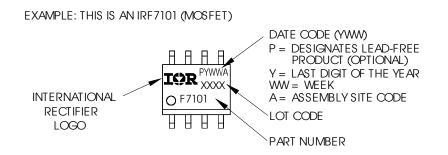
International

SO-8 Package Outline

Dimensions are shown in milimeters (inches)



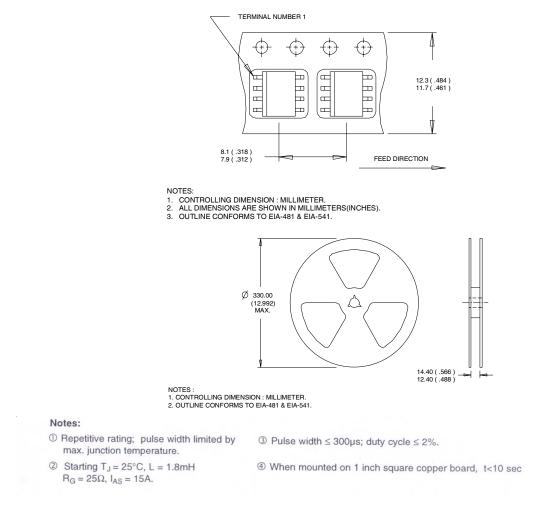
SO-8 Part Marking Information (Lead-Free)



International

SO-8 Tape and Reel

Dimensions are shown in milimeters (inches)



Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market. Qualifications Standards can be found on IR's Web site.

International

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903 Visit us at www.irf.com for sales contact information.06/04 8